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## Folded dipole antenna for CC2400, CC2420, CC2430 and CC2431

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### 1 KEYWORDS

- *Radiation diagram*
- *Line of sight range*
- *CC2400*
- *CC2420*
- *CC2430*
- *CC2431*
- *Folded dipole*

### 2 INTRODUCTION

This application note describes the design of a folded dipole antenna for *CC2400*, *CC2420*, *CC2430* and *CC2431*. The *CC2400* is a true single-chip, general-purpose transceiver for the 2.4 GHz SRD band for data rates up to 1 Mbps. The *CC2420* is a true single-chip RF transceiver designed for low power wireless networks operating in the 2.4 GHz SRD band compliant to the ZigBee™/IEEE 802.15.4 standards. *CC2430* is a true SOC combining the *CC2420* with a single cycle 8051 microcontroller. *CC2431* is *CC2430* with location engine.

The design described in this application note is based on the *CC2400*, but it can be used for *CC2420*, *CC2430* and *CC2431* as they have the same RF front end. The RF

front end consists of three pin connections. Two pins serve as a differential interface shared by the LNA and PA. The third pin changes voltage level in order to provide power to the PA during transmission and ground to the LNA during reception. A differential interface provides a better utilisation of the available supply voltage as well as less parasitic capacitance to ground.

Design criteria for the antenna and the design process are described. Also included are test results and a comparison of the tested antenna to a balun and monopole antenna solution. Gerber files and schematics can be downloaded from Chipcon's web site.

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### 3 ABBREVIATIONS

DC	Direct Current
EB	Evaluation Board
EIRP	Effective Isotropic Radiated Power
EM	Electromagnetic
CC2400EM	CC2400 Evaluation Module
FCC	Federal Communications Commission
FR4	Common PCB material
FSK	Frequency Shift Keying
LNA	Low Noise Amplifier
PA	Power Amplifier
PCB	Printed Circuit Board
RBW	Resolution Bandwidth
RF	Radio Frequency
RFC	Radio Frequency Choke
SMA	Common RF connector
SRD	Short Range Device
VBW	Video Bandwidth

## 4 DESIGN CRITERIA

The following design criteria were important for the antenna design:

- Optimum load impedance  $115 + j180$  Ohm, differential
- DC-connection between RF pins and TXRX\_switch pin
- TXRX\_switch pin isolated from RF
- Few components
- Manufacturability
- Low spurious emission
- Low losses
- Omnidirectionality

The optimum termination impedance is a trade-off between optimum source impedance for the internal LNA and optimum load for the internal PA. The TXRX\_switch pin level is 0 V in receive mode to provide ground for the LNA and 1.8 V in transmit mode to provide the required supply voltage to the PA. This pin should be isolated from the RF signals by using a shunt capacitor and/or a series inductor (RFC).

Antennas that are electrically short compared to the wavelength tend to be sensitive to component variations in the tuning network. Electrically small antennas may cause yield problems or require individual tuning.

Pay special attention to the harmonic levels for operation in the 2.4 GHz SRD band. Both the second and third harmonic will fall within protected bands as defined by FCC part 15.

In typical SRD applications, it is desired that the antenna radiates equally in all directions, i.e. that the antenna is omni directional.

A folded dipole is attractive because of its high impedance that makes it easier to match to the optimum impedance for the **CC2400**. The theoretical impedance is 292 Ohm for a half wavelength folded dipole. A shunt inductor should provide the inductive part of the optimum load impedance while reducing the real part. The folded dipole is a metal loop that will provide DC contact between the RF pins. In addition the mid point of the antenna is virtual ground, meaning that a connection can be made to the TXRX switch pin without distorting antenna performance. The folded dipole is a resonant structure that should be less sensitive to component variations and provide low losses. The radiation pattern of a folded dipole is omni-directional in the plane normal to the antenna.

## 5 DESIGN DESCRIPTION

An initial investigation to check the feasibility of the design was performed using the Smith chart. Plotting the 292 Ohm in the Smith chart and adding a 15 nH shunt inductor resulted in  $115 + j141$  Ohm.

The CC2400EM reference design was selected as the base for the design. The CC2400EM is a radio module with balun and an SMA connector. The balun with the SMA connector is designed to work with 50 Ohm unbalanced devices such as a  $\frac{1}{4}$  wave antenna and most RF instruments

The antenna was implemented on the PCB as part of the layout. The antenna was placed relatively close to the *CC2400* to keep the design compact.

The antenna design was simulated before the layout was made. The antenna was designed using an EM simulator and the matching circuit was simulated using a linear simulator and S-parameters from the EM simulation.

The first step in the simulation was to design a folded dipole on a FR4 PCB in front of a ground plane of the same size as the CC2400EM. The length of the antenna was adjusted until the impedance was 290 Ohm. The next step was to add feed lines with pads for a shunt inductor and a transmission line to the virtual ground point of the antenna for DC connection to the TXRX switch pin. The transmission line to the TXRX switch pin was connected to ground during the simulations and was fitted with pads for a series inductor. The inductor pads were defined as ports to make it easy to simulate with various inductors in the following S-parameter simulations. Due to the PCB material and the ground plane, the antenna became shorter than the theoretical half wavelength. Finally, the inductor values were determined using a linear simulator, S-parameters from the antenna simulation and S-parameters for the inductors.

## **6 SCHEMATICS AND LAYOUT**

Figure 1 shows the schematic of the CC2400EM with the folded dipole antenna. Figure 2 shows the board layout. The distance to the antenna and extension of the ground plane behind the antenna are critical parameters. If the PCB is wider than the CC2400EM board, the ground plane, components and tracks should be pulled away from the end points of the antenna.



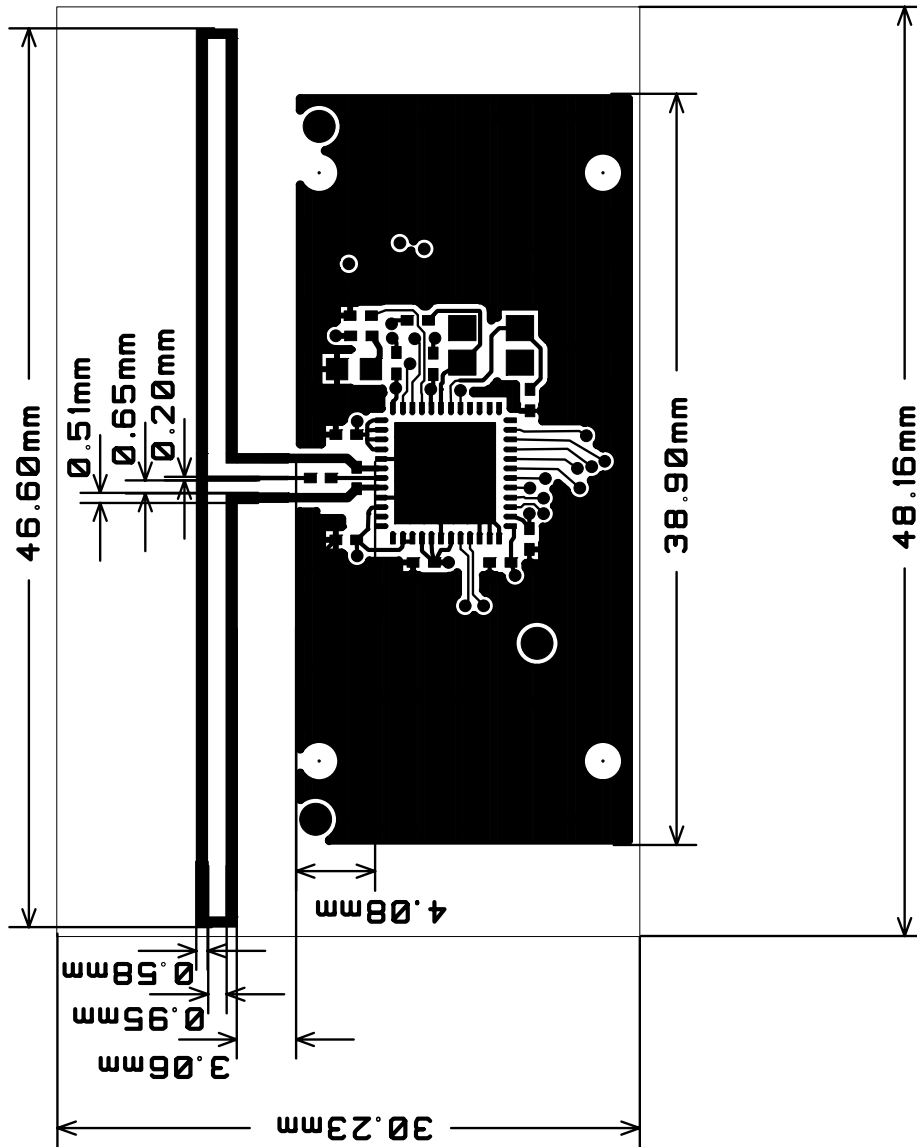
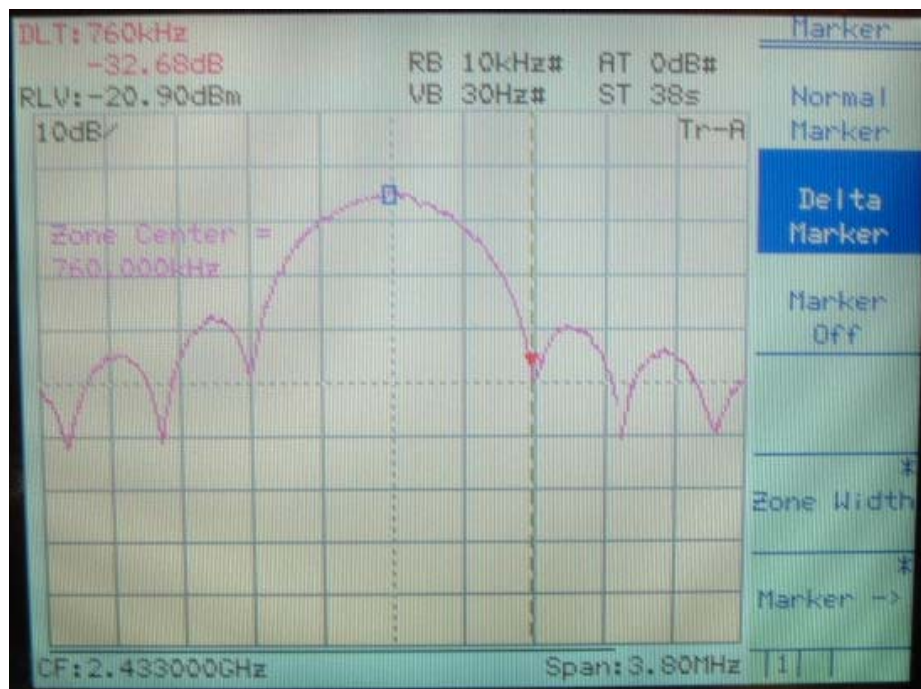


Figure 2: Layout of CC2400EM with folded dipole.

## 7 TUNING

The purpose of tuning is to maximise output power while maintaining good spectrum properties. Figure 3 shows the spectrum when **CC2400** is configured to transmit continuously random data at 1 Mbps. It is measured with a cable between the spectrum analyser and the CC2400EM. The cable and the instrument is 50 Ohm and a good impedance match for the CC2400EM. Figure 3 also illustrates how to judge a good spectrum. The marker measures the difference between the peak power level and the first null. It should be at least 25 dB, typically 28 dB, for no degradation in transmission. The difference in frequency is 760 kHz. It is important to measure with 100 kHz RBW and a 100kHz VBW. It is also an advantage to apply averaging for the measurements over the air. (Note: The plot use different settings on RBW and VBW)



**Figure 3: Reference spectrum for CC2400 at 1 Mbps.**

Poor matching degrades the output spectrum as illustrated in Figure 4. This measurement is obtained using an antenna connected to the spectrum analyser. The CC2400EM is tested with no antenna connected to, i. e. the SMA connector left open. In this case the mismatch occurs due to the open circuit when the antenna is removed from the EM. Transmission is lost even at small distances because of spectrum degradation. The received level is adequate, but the FSK signal is too degraded to be demodulated.

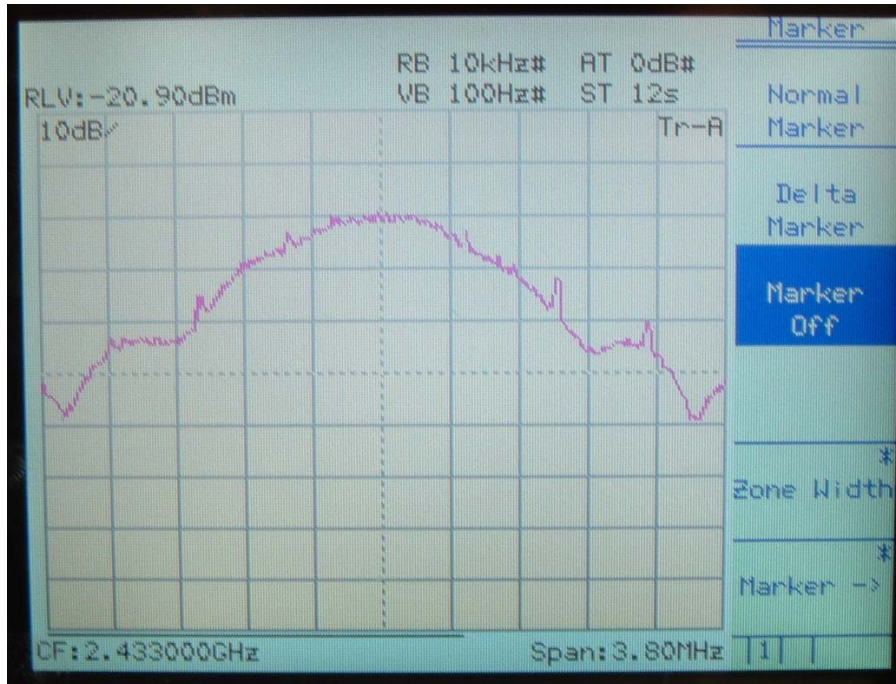
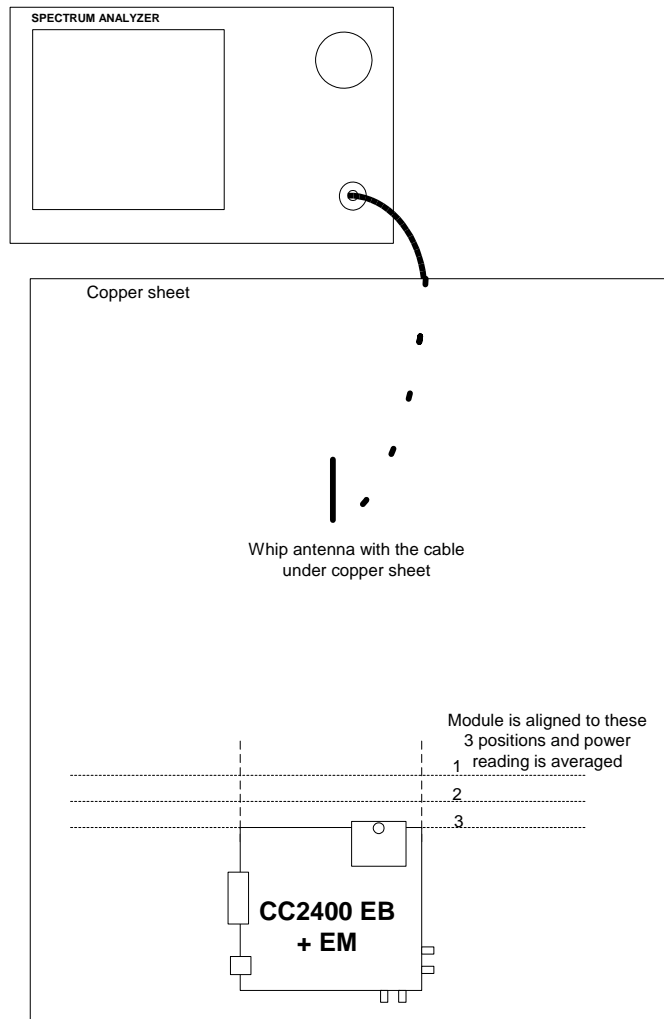


Figure 4: Example of poor spectrum, antenna removed from EM.

The tuning set up is shown in Figure 5. It consists of a whip antenna mounted on a copper sheet and connected to a spectrum analyser. A copper sheet is not required; it was used to have a stable set-up. To achieve reliable measurements, the CC2400 EB onto which the CC2400 EM to be tested was mounted, was placed in three different positions on the copper sheet. The power received by the whip antenna was read in the three positions and the average was used for comparison of the different configurations. The tuning of the antenna was performed in a laboratory without absorbers or other features for antenna characterisation. It is important to average measurements as small changes in position could give significant changes in received levels due to reflections. The RBW was set to 2 MHz with a 3.8 MHz span and averaging was set to 50 when making power measurements. The spectrum was checked using an RBW = VBW = 100 kHz. The inductor values were stepped up and down and the average power level was recorded as well as the depth of the first nulls in the spectrum.



**Figure 5: Tuning setup.**

## 8 TEST RESULTS

The folded dipole antenna was tested and compared to the whip antenna that ships with the Chipcon CC24XXDK development kits.

The radiation patterns were tested in an anechoic chamber. All radiation patterns are included in the appendix. The measurements are made for vertical and horizontal polarisations with sweeps made in 3 planes. The output power of CC2400 was programmed to 0 dBm and the measurements were calibrated to show EIRP. The whip antenna (Figure 6) has a vertical orientation when the EB is parallel with the xy-plane. That is why the gain is highest for the plot with vertical polarisation. The folded dipole (Figure 7) has a horizontal orientation and the gain is highest for the plot with horizontal polarisation. The positions of the EB with antennas are shown in Figure 8, Figure 9, and Figure 10.

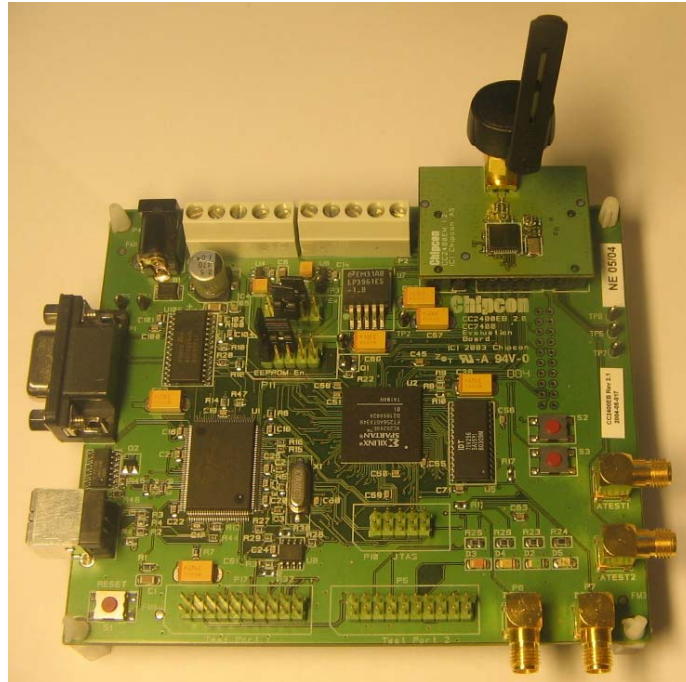


Figure 6: EB with CC2400EM with whip antenna.

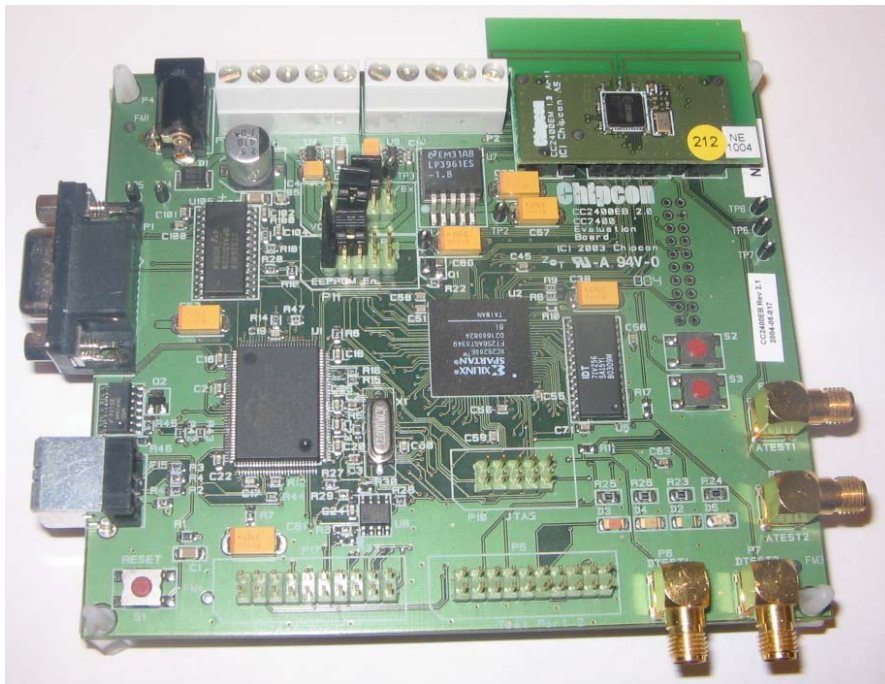


Figure 7: EB with CC2400EM with folded dipole antenna.

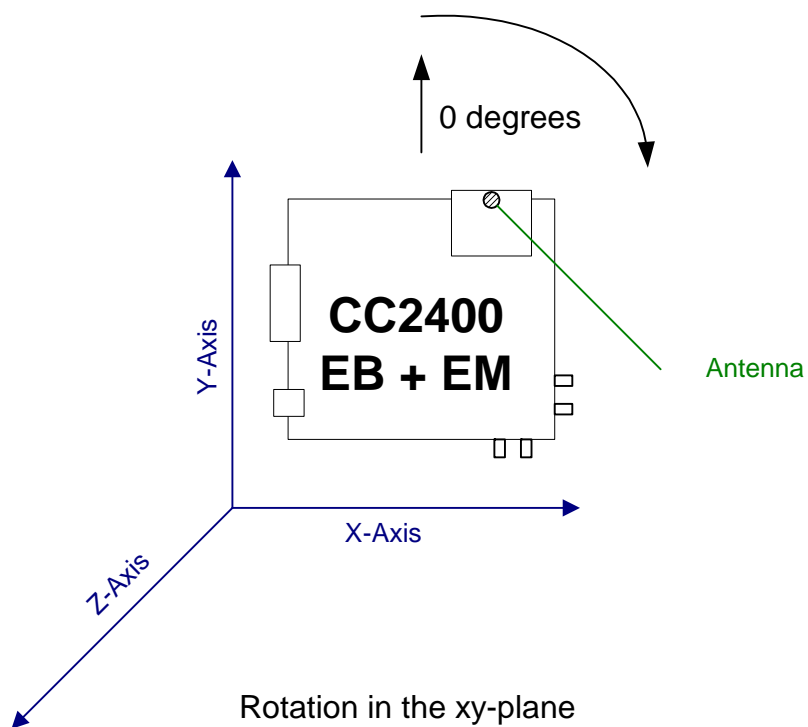


Figure 8: Orientation of antenna, EM and EB for sweep in xy-plane.

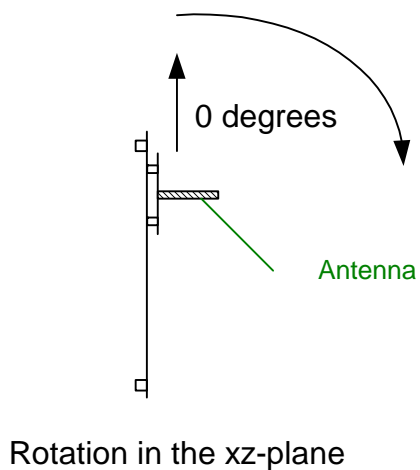


Figure 9: Orientation of antenna, EM and EB for sweep in xz-plane.

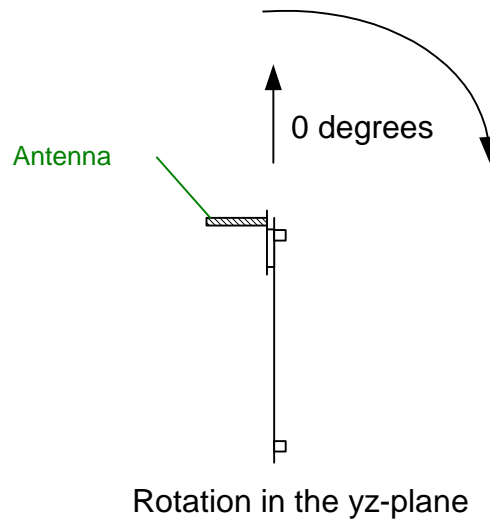


Figure 10: Orientation of antenna, EM and EB for sweep in yz-plane.

### 1.1. Summary of results

Table 1 shows a summary of the results associated with the two designs, i.e. for the CC2400EM with balun and whip antenna and the CC2400EM with a folded dipole.

Antenna:	Whip	Folded dipole
Gain	+ 1.9 dBi	+0.3 dBi
Omnidirectivity	6 dB dip, best case	16 dB dip, best case
Harmonics (FCC part 15, req. max. 54 dB $\mu$ V/m)	2 <sup>nd</sup> : 52.8 3 <sup>rd</sup> : 49.4	2 <sup>nd</sup> : 52.0 3 <sup>rd</sup> : 51.3
Components	Discrete balun requires 4 inductors and 4 capacitors	Requires 2 inductors
Size including matching network	Without antenna: 8 mm by 4 mm	Antenna and match: 47 mm by 9 mm
Line of sight range outdoors with CC2400	212 meter	157 meter

Table 1: Summary of results.

## 9 CONCLUSION

The folded dipole is an inexpensive, differential alternative to a balun and single ended antenna.

10 APPENDIX A - RADIATION DIAGRAMS

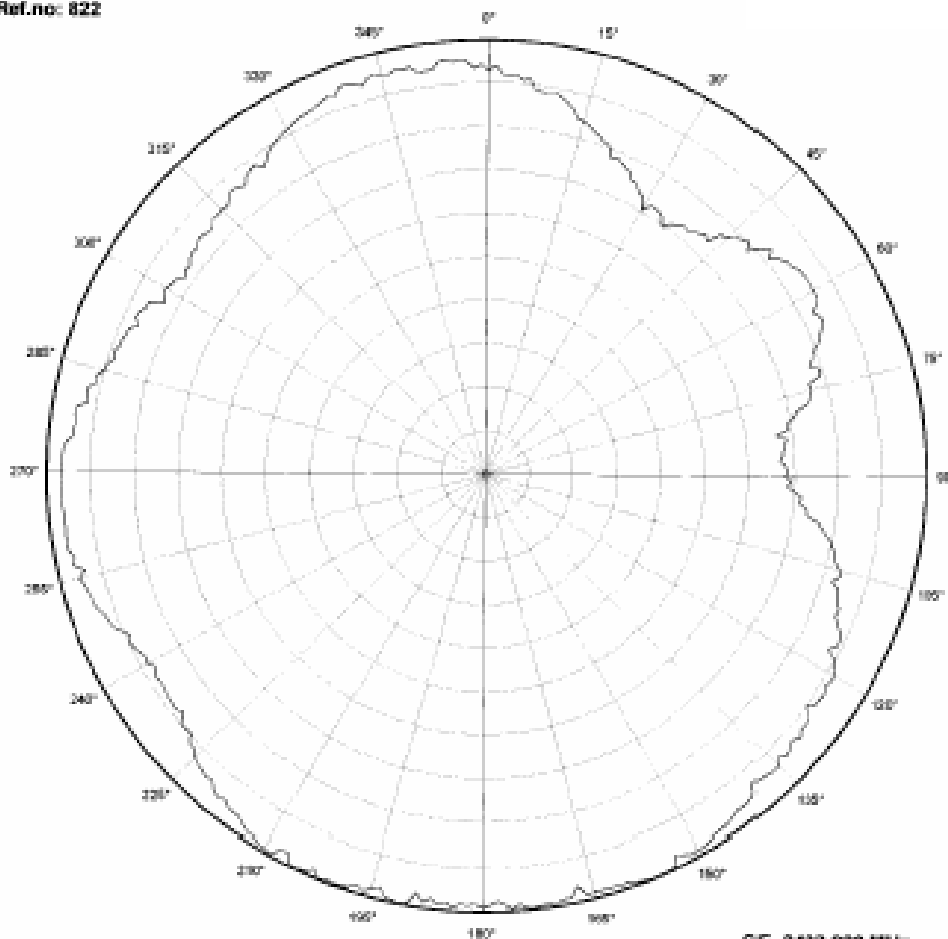
Antenna Characteristics

Nemko Comlab

18-NOV-2004 10:02

Ref.no: 822

Whip, DK  
xy-plane



CF 2433.000 MHz  
2 dBi/div  
Ref Lev: 1.9 dBm

Vertical Polarization

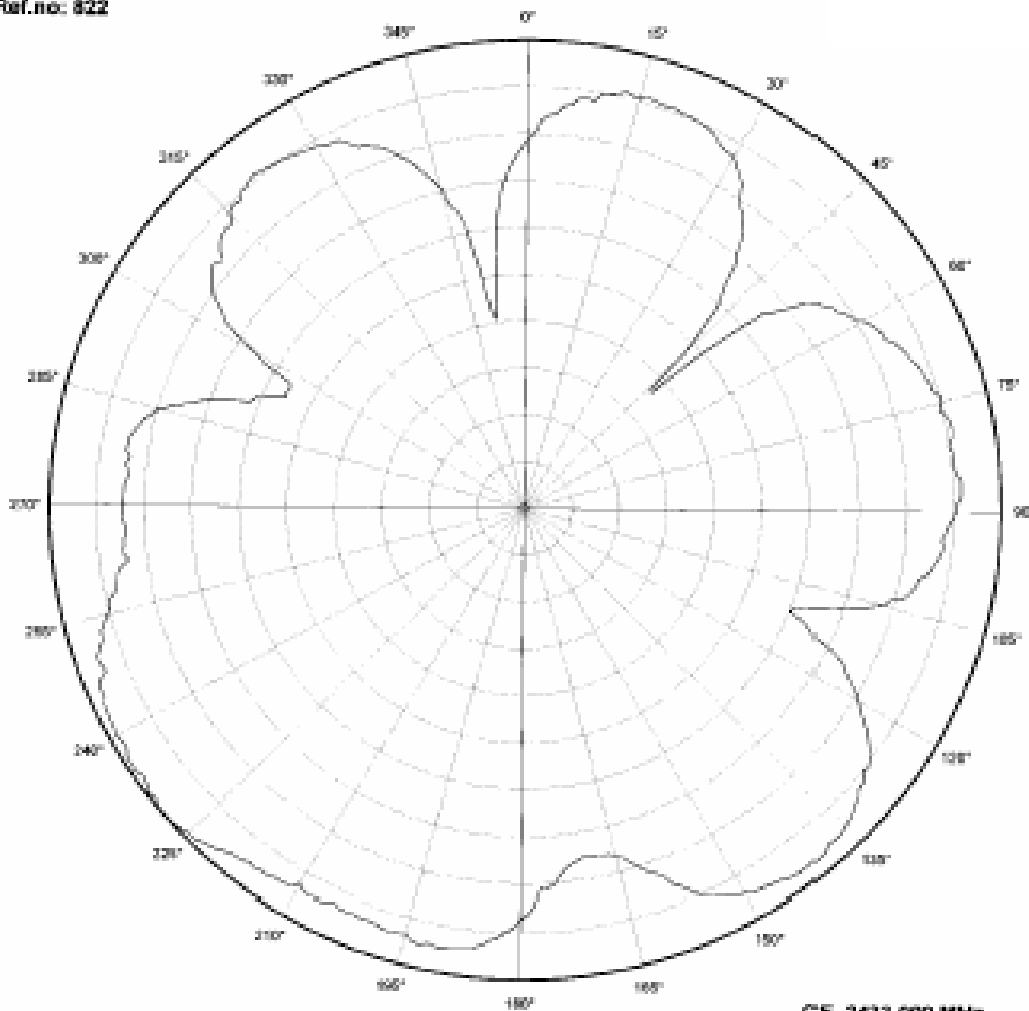
Antenna Characteristics

Nemko Comlab

18-NOV-2004 10:03

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Whip, DK  
xy-plane



Horizontal Polarization

CF 2433.000 MHz  
5-dB/div  
Ref Lev: -43 dBm

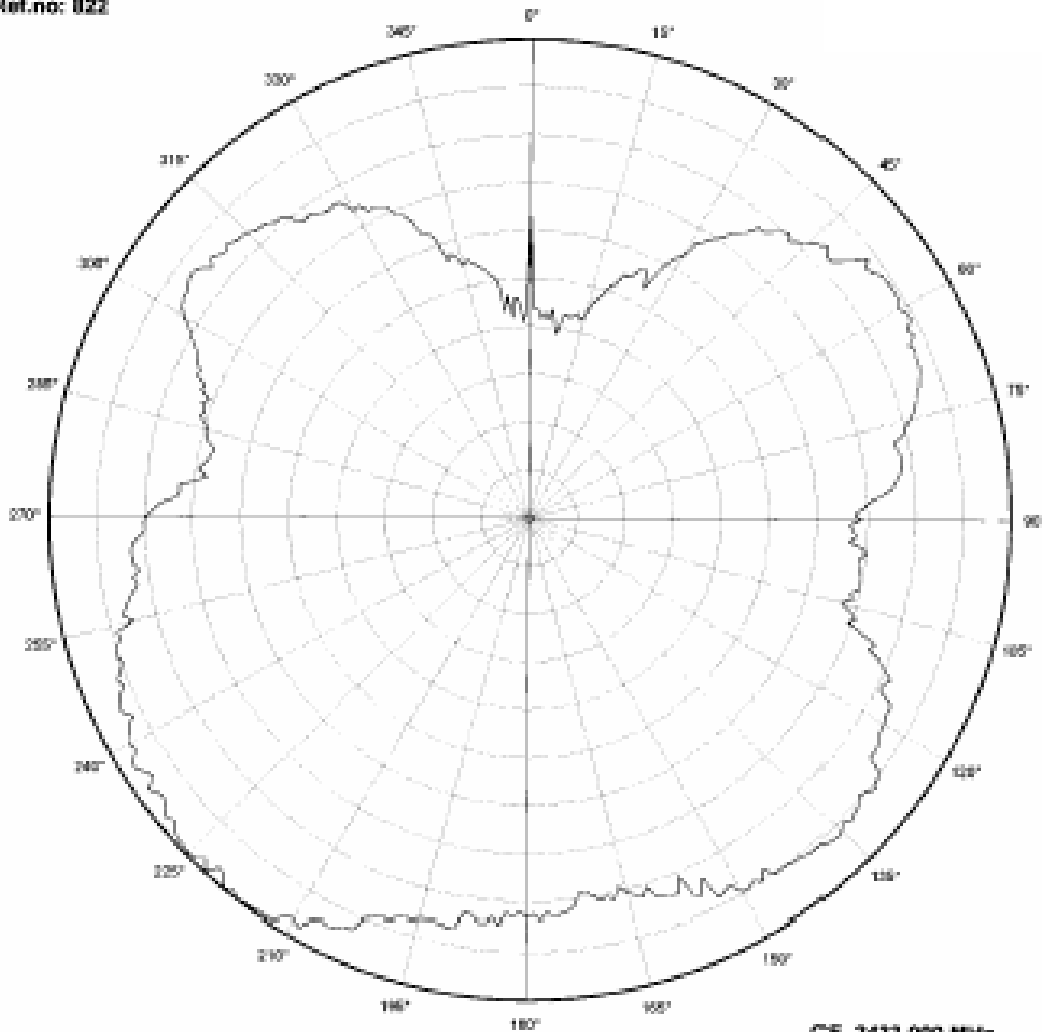
Antenna Characteristics

Nemko Comlab

18-NOV-2004 10:42

Ref.no: 022

Whip, DK  
xz-plane



CF 2433.000 MHz  
2 dB/div  
Ref Lev: -6.4 dBm

Vertical Polarization

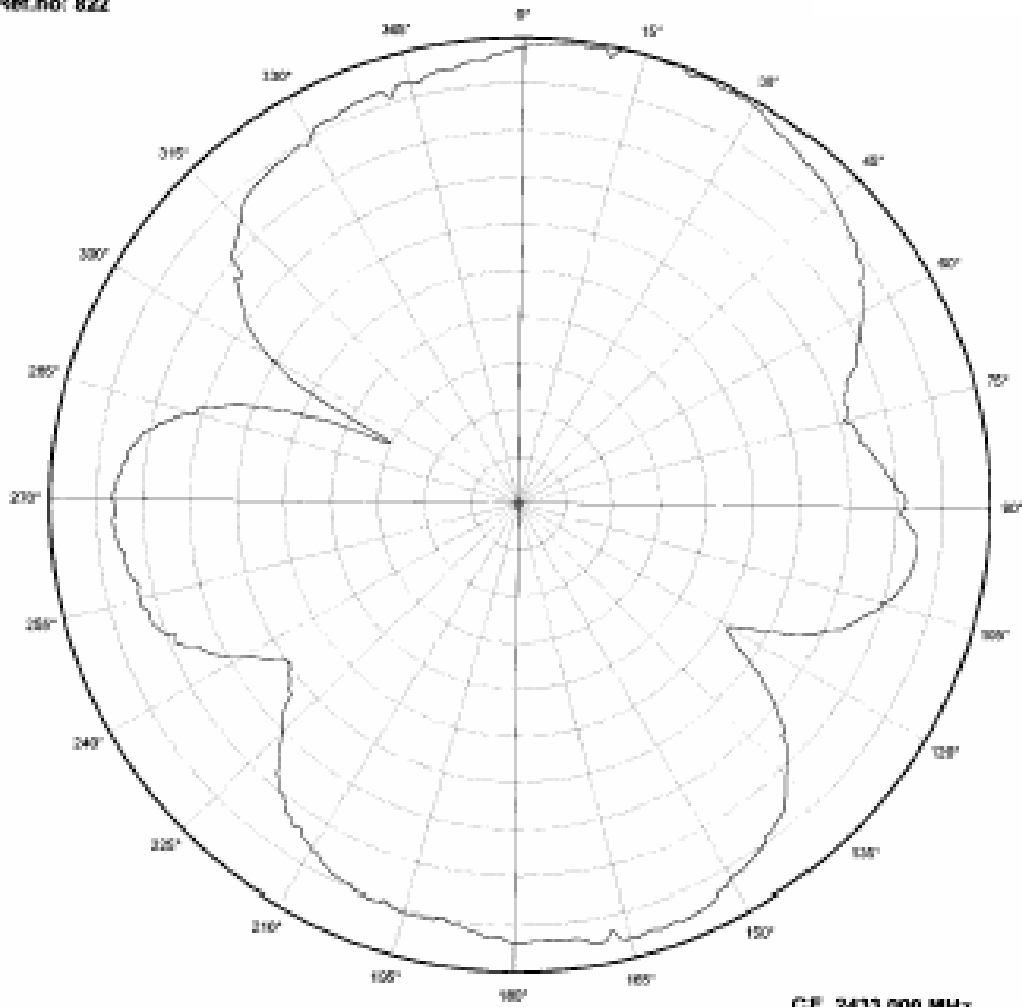
Antenna Characteristics

Nemko Comlab

18-NOV-2004 10:30

Ref.no: 822

Whip, DK  
xz-plane



Horizontal Polarization

CF 2433.000 MHz  
4 dB/div  
Ref Lev: 14 dBm

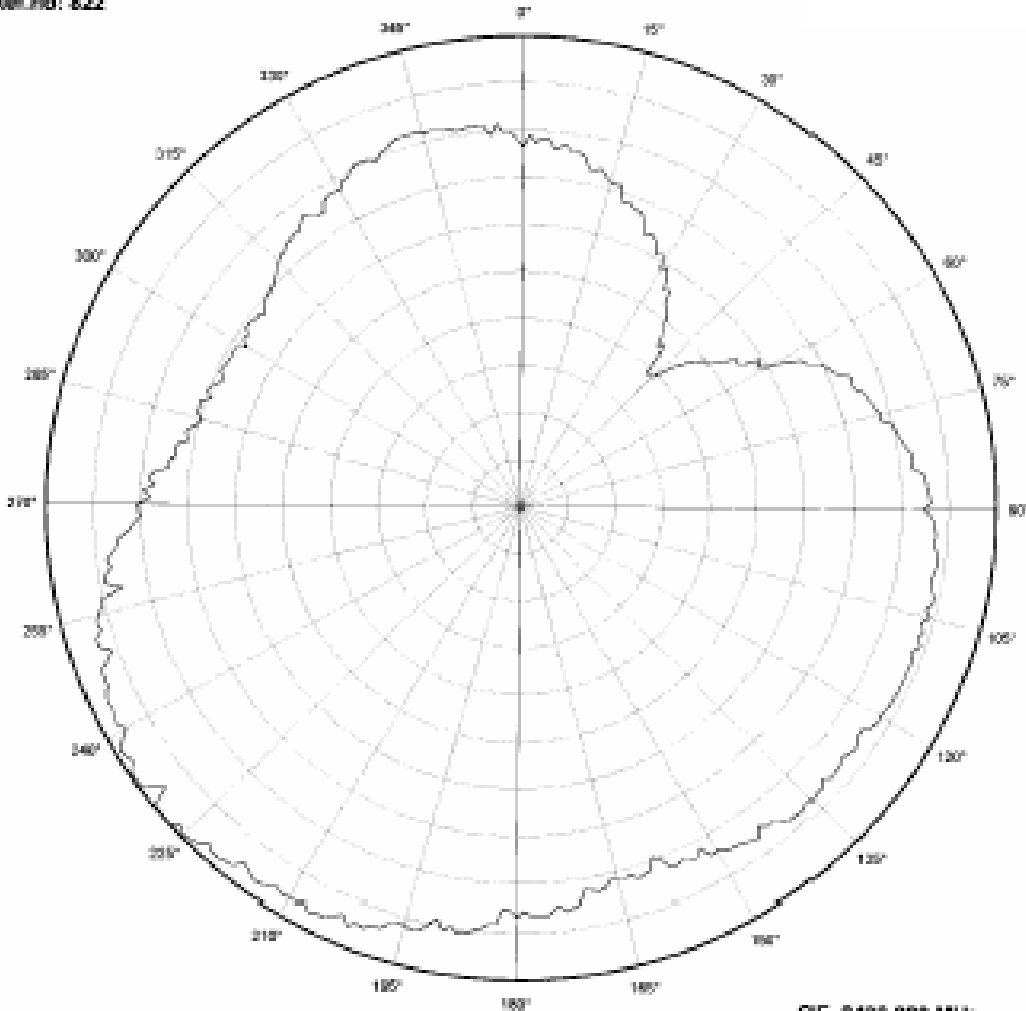
Antenna Characteristics

Nemko Comlab

18-NOV-2004 10:17

Ref.no: 822

Whip, DK  
yz-plane



CF 2433.000 MHz  
2 dBi/div  
Ref Lev: -3.8 dBm

Vertical Polarization

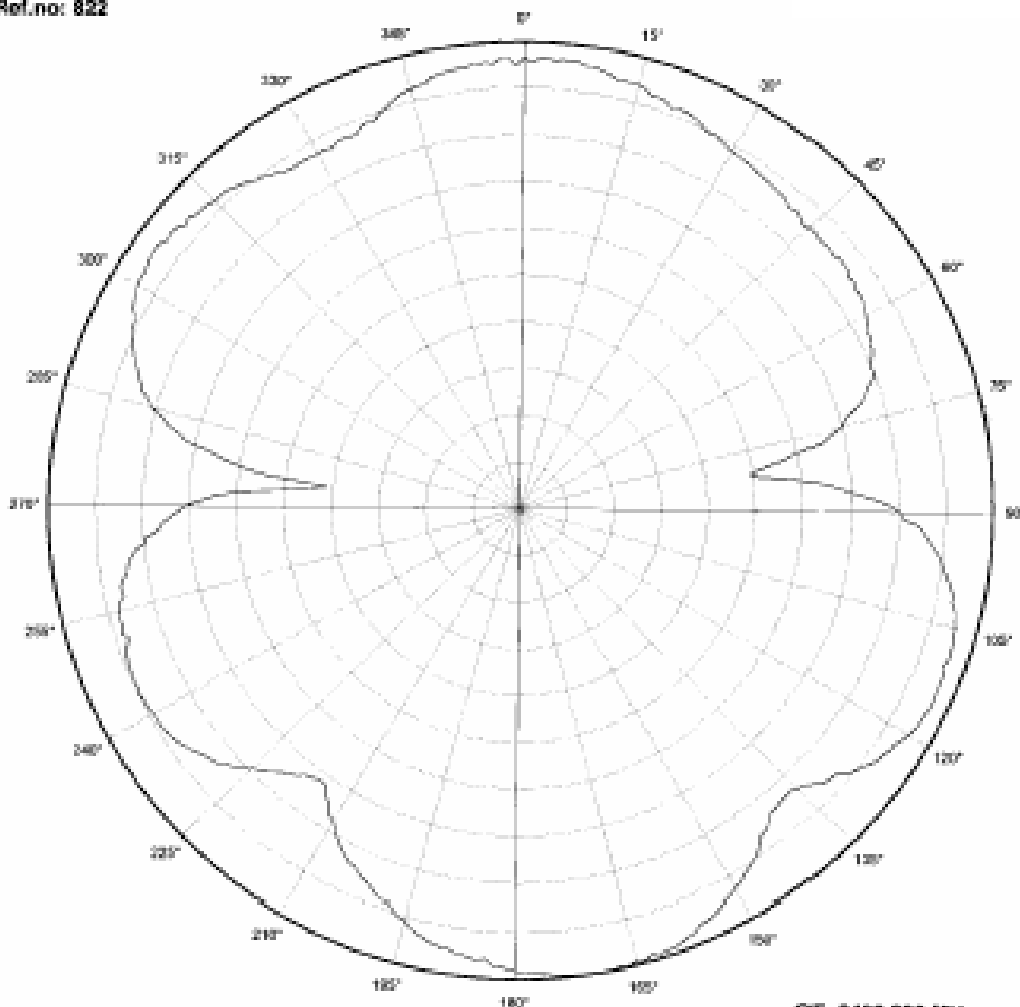
Antenna Characteristics

Whip, DK  
yz-plane

Nemko Comlab

19-NOV-2004 10:18

Ref.no: 822



CF 2433.000 MHz  
5 dB/div  
Ref Lev: 19 dBm

Horizontal Polarization

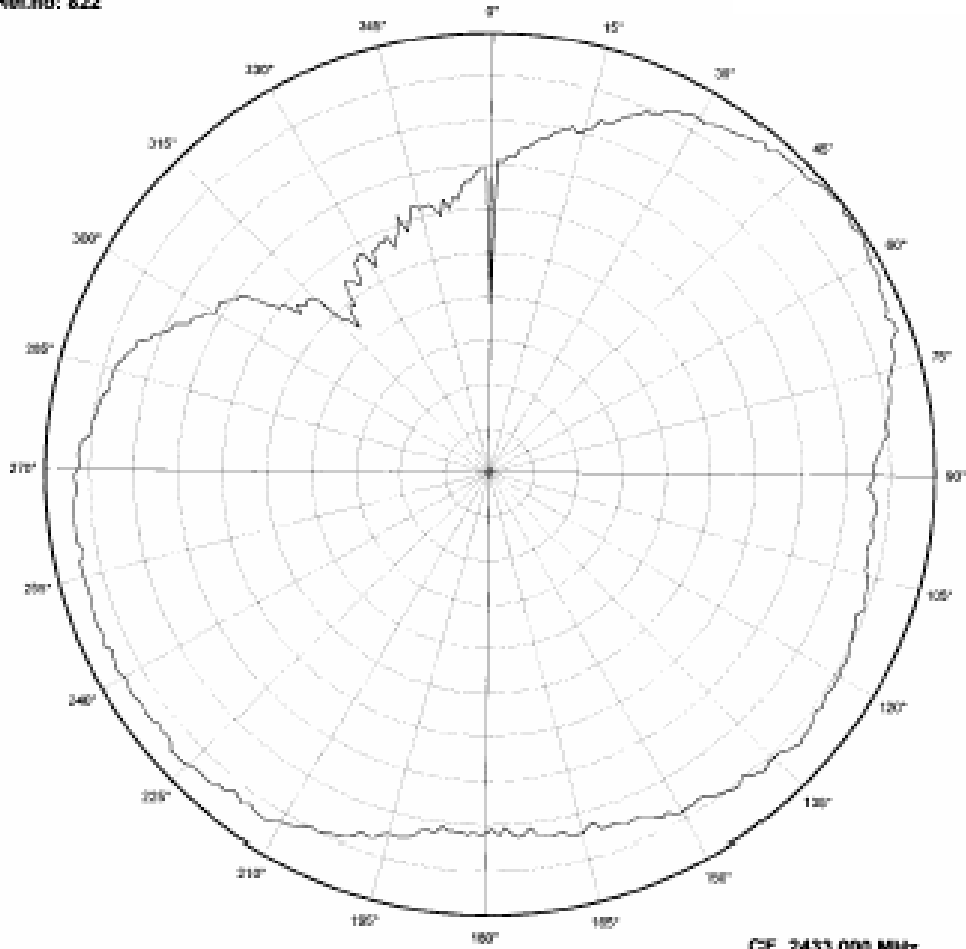
Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:00

Ref.No: 822

Folded dipole  
xy-plane



Vertical Polarization

CF 2433.000 MHz  
4 dB/div  
Ref Lev: -11.6 dBm

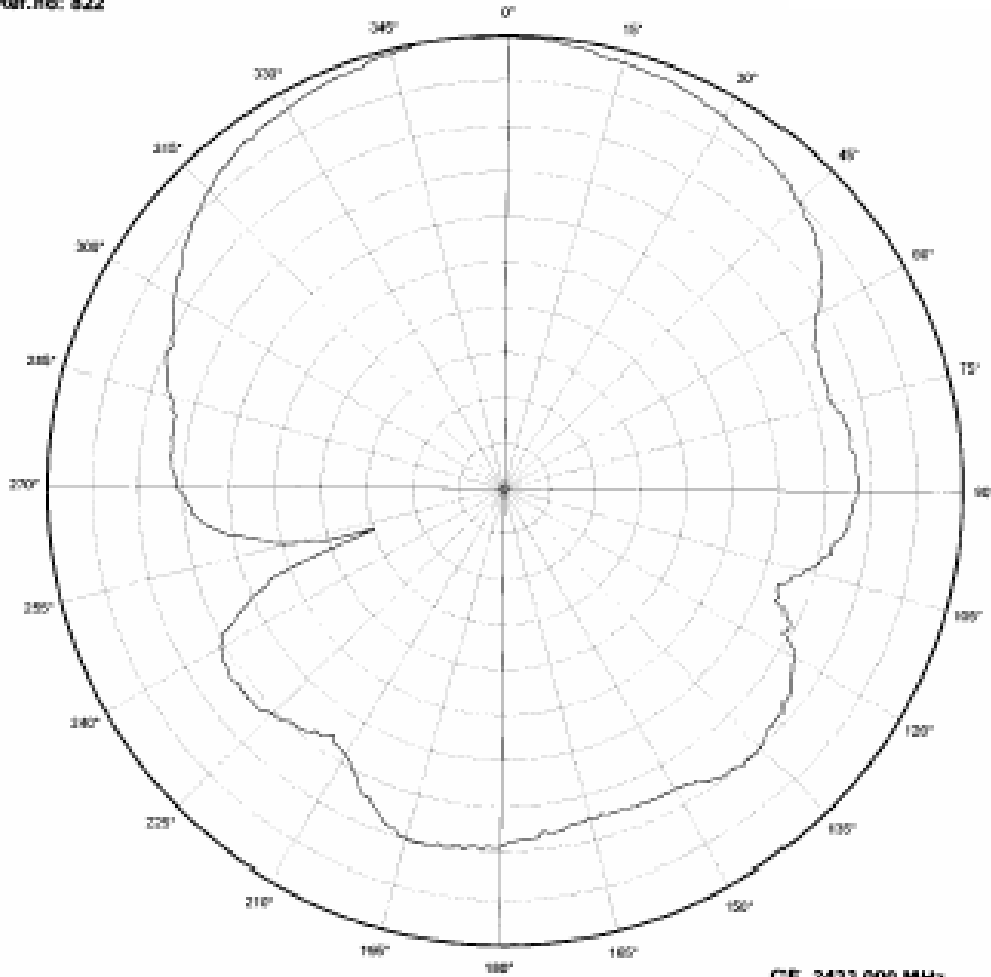
## Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:02

Ref.no: 822

Folded dipole  
xy-plane



CF 2433.000 MHz

5 dB/div

Ref Lev:  $-14$  dBm

Horizontal Polarization

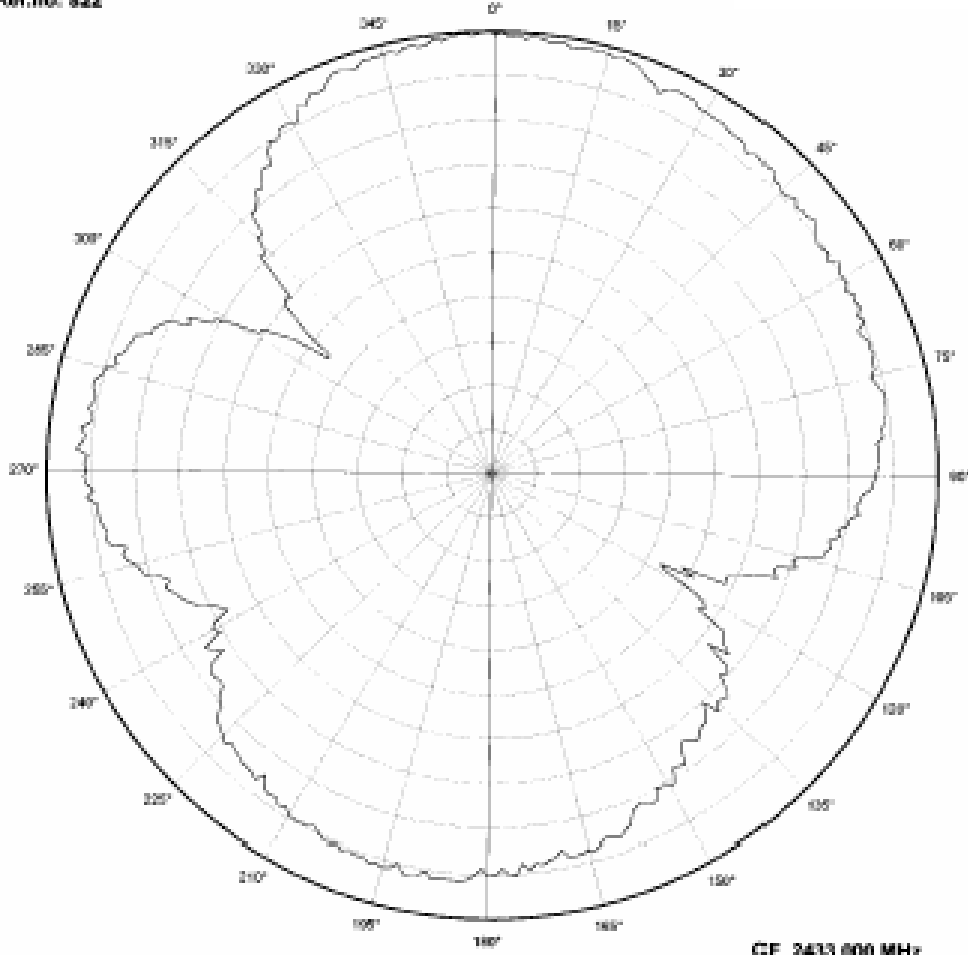
Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:19

Ref.no: 822

Folded dipole  
xz-plane



Vertical Polarization

CF 2433.600 MHz  
4 dB/div  
Ref Lev: -16.1 dBm

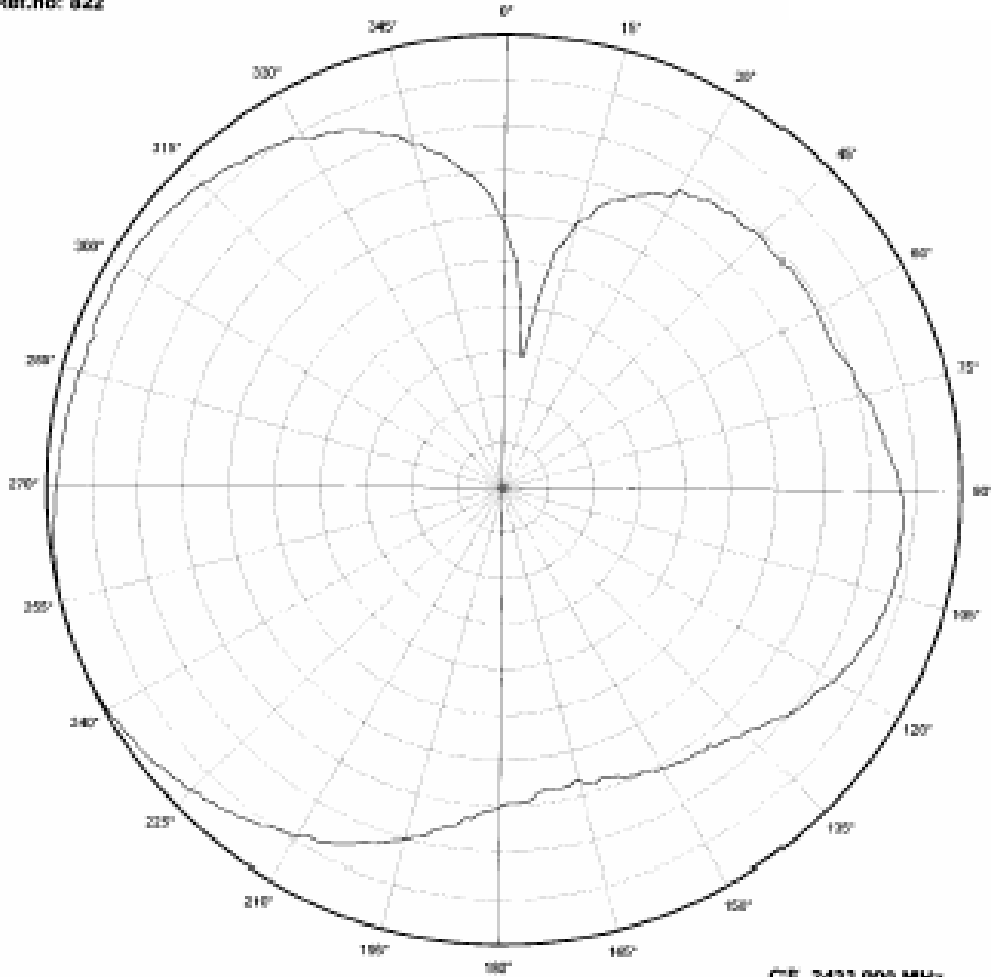
Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:21

Ref.no: 022

Folded dipole  
xz-plane



CF 2433.000 MHz  
5 dB/div  
Ref Lev: -91 dBm

Horizontal Polarization

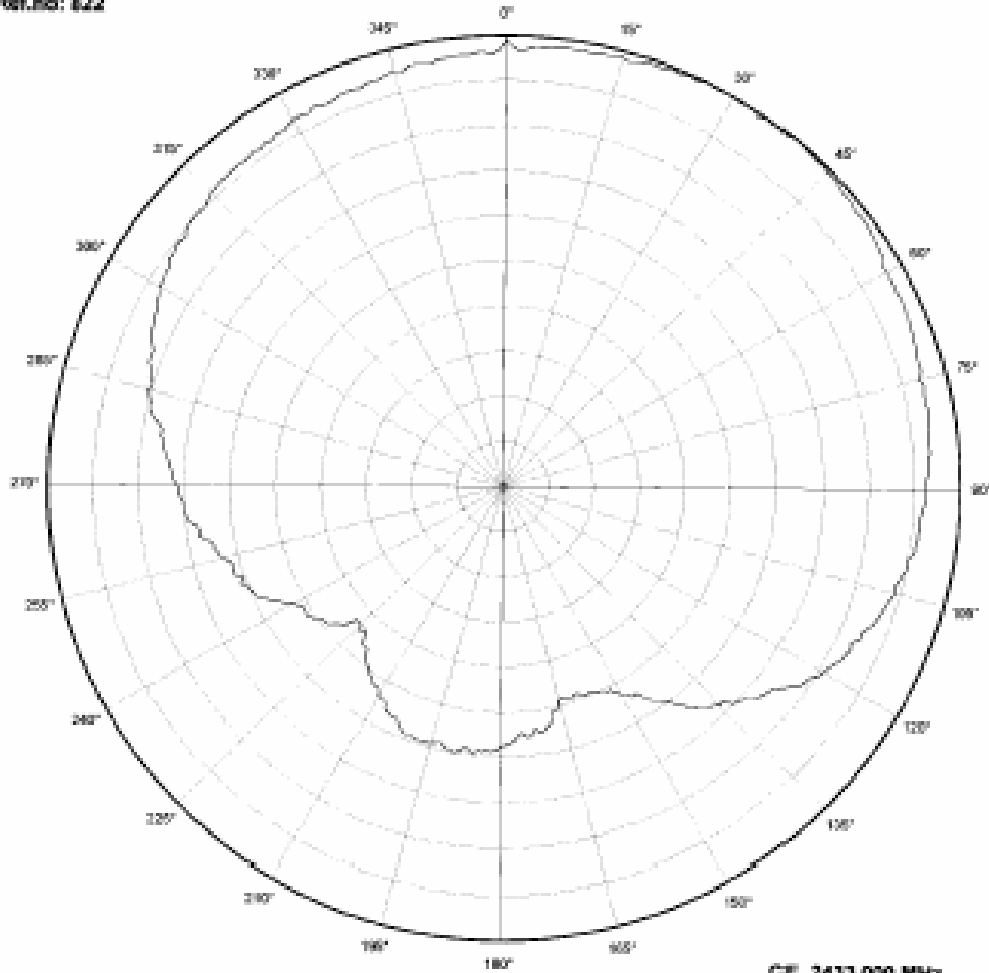
Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:10

Ref.no: 022

Folded dipole  
yz-plane



Vertical Polarization

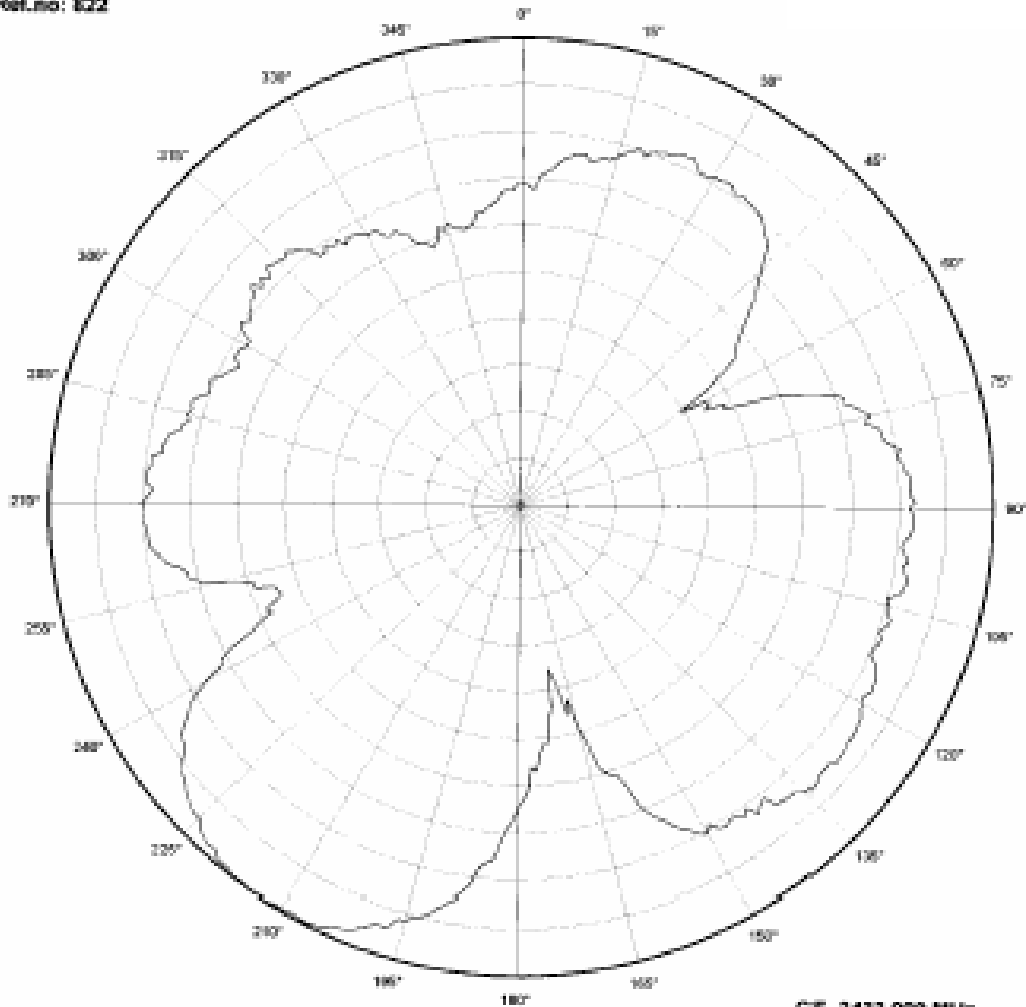
### Antenna Characteristics

Nemko Comlab

18-NOV-2004 11:11

Ref.no: 822

Folded dipole  
yz-plane



Horizontal Polarization

CF 3433.000 MHz  
3 dBi/div  
Ref Lev: -10.00 dBm

## 11 GENERAL INFORMATION

### 1.2. Document History

Revision	Date	Description/Changes
1.0	2006-01-09	Initial release.

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